# Onsemi

# **Octal 3-State Buffer,** Inverting/Non-Inverting

# **MM74HCT540**, **MM74HCT541**

#### **General Description**

The MM74HCT540 and MM74HCT541 3-STATE buffers utilize advanced silicon-gate CMOS technology and are general purpose high speed inverting and non-inverting buffers. They possess high drive current outputs which enable high speed operation even when driving large bus capacitances. These circuits achieve speeds comparable to low power Schottky devices, while retaining the low power consumption of CMOS. Both devices are TTL input compatible and have a fanout of 15 LS-TTL equivalent inputs.

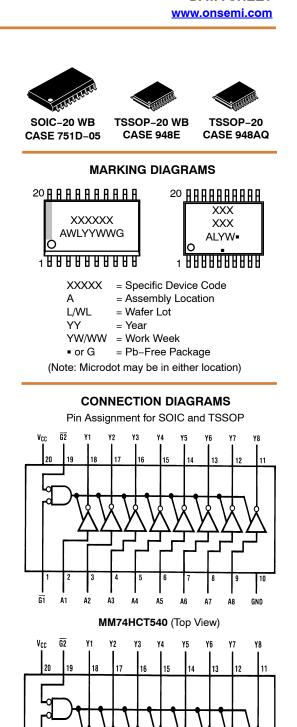
MM74HCT devices are intended to interface between TTL and NMOS components and standard CMOS devices. These parts are also plug-in replacements for LS-TTL devices and can be used to reduce power consumption in existing designs.

The MM74HCT540 is an inverting buffer and the MM74HCT541 is a non-inverting buffer. The 3-STATE control gate operates as a two-input NOR such that if either  $\overline{G1}$  or  $\overline{G2}$  are HIGH, all eight outputs are in the high-impedance state.

In order to enhance PC board layout, the MM74HCT540 and MM74HCT541 offers a pinout having inputs and outputs on opposite sides of the package. All inputs are protected from damage due to static discharge by diodes to V<sub>CC</sub> and ground.

#### Features

- TTL Input Compatible
- Typical Propagation Delay: 12 ns
- 3-STATE Outputs for Connection to System Buses
- Low Quiescent Current: 160 μA
- Output Current: 6 mA (min)
- These are Pb-Free Devices



#### **ORDERING INFORMATION**

MM74HCT541 (Top View)

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

GI A1 A2 A3 A4 A5 Afi A7 **A**8 GND

#### ABSOLUTE MAXIMUM RATINGS (Note 1)

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply Voltage	–0.5 to +7.0	V
V <sub>IN</sub>	DC Input Voltage	–0.5 to V <sub>CC</sub> + 0.5	V
V <sub>OUT</sub>	DC Output Voltage	–0.5 to V <sub>CC</sub> + 0.5	V
I <sub>IK</sub> , I <sub>OK</sub>	Clamp Diode Current	±20	mA
I <sub>OUT</sub>	DC Output Current, per Pin	±35	mA
I <sub>CC</sub>	DC V <sub>CC</sub> or GND Current, per Pin	±70	mA
T <sub>STG</sub>	Storage Temperature Range	–65 to +150	°C
P <sub>D</sub>	Power Dissipation S. O. Package Only	500	mW
ΤL	Lead Temperature (Soldering 10 seconds)	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Unless otherwise specified all voltages are referenced to ground.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage	4.5	5.5	V
V <sub>IN</sub> , V <sub>OUT</sub>	DC Input or Output Voltage	0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature Range	-55	+125	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise or Fall Times	-	500	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

#### DC ELECTRICAL CHARACTERISTICS (V<sub>CC</sub> = 5 V ±10% unless otherwise specified)

			T <sub>A</sub> =	25°C	$T_A = -40^{\circ}C$ to $85^{\circ}C$	T <sub>A</sub> = −55°C to 125°C	
Symbol	Parameter	Conditions	Тур		Guaranteed L	imits	Unit
V <sub>IH</sub>	Minimum HIGH Level Input Voltage		-	2.0	2.0	2.0	V
V <sub>IL</sub>	Maximum LOW Level Input Voltage		_	0.8	0.8	0.8	V
V <sub>OH</sub>	Minimum HIGH Level Output Voltage		V <sub>CC</sub> 4.2 5.2	V <sub>CC</sub> -0.1 3.98 4.98	V <sub>CC</sub> -0.1 3.84 4.84	V <sub>CC</sub> -0.1 3.7 4.7	V
V <sub>OL</sub>	Maximum LOW Level Voltage		0 0.2 0.2	0.1 0.26 0.26	0.1 0.33 0.33	0.1 0.4 0.4	V
I <sub>IN</sub>	Maximum Input Current	$V_{IN} = V_{CC}$ or GND	-	±0.1	±1.0	±1.0	μΑ
I <sub>OZ</sub>	Maximum 3–STATE Output Leakage Current	$V_{OUT} = V_{CC}$ or GND $\overline{G} = V_{IH}$	-	±0.5	±5.0	±10	μΑ
I <sub>CC</sub>	Maximum Quiescent Supply Current	$V_{IN} = V_{CC} \text{ or GND}$ $I_{OUT} = 0 \ \mu A$	-	8.0	80	160	μΑ
		V <sub>IN</sub> = 2.4 V or 0.5 V (Note 2)	0.6	1.0	1.3	1.5	mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Measured per input. All other inputs at V<sub>CC</sub> or GND.

#### **AC ELECTRICAL CHARACTERISTICS**

(MM74HCT540: V\_{CC} = 5.0 V,  $t_r = t_f = 6$  ns,  $T_A = 25^{\circ}C$ , unless otherwise specified)

Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Unit
t <sub>PHL</sub> , t <sub>PLH</sub>	Maximum Output Propagation Delay	C <sub>L</sub> = 45 pF	12	18	ns
t <sub>PZL</sub> , t <sub>PZH</sub>	Maximum Output Enable Time	$C_L$ = 45 pF, $R_L$ = 1 k $\Omega$	14	28	ns
t <sub>PLZ</sub> , t <sub>PHZ</sub>	Maximum Output Disable Time	$C_L = 5 \text{ pF}, R_L = 1 \text{ k}\Omega$	13	25	ns

#### AC ELECTRICAL CHARACTERISTICS

(MM74HCT540:  $V_{CC}$  = 5.0 V  $\pm 10\%,\,t_r$  =  $t_f$  = 6 ns, unless otherwise specified)

			T <sub>A</sub> =	25°C	$T_A = -40^{\circ}C$ to $85^{\circ}C$	$T_A = -55^{\circ}C$ to $125^{\circ}C$	
Symbol	Parameter	Conditions	Тур		Guaranteed L	imits	Unit
t <sub>PHL</sub> , t <sub>PLH</sub>	Maximum Output	C <sub>L</sub> = 50 pF	12	20	25	30	ns
	Propagation Delay	C <sub>L</sub> = 150 pF	22	30	38	45	
t <sub>PZH</sub> , t <sub>PZL</sub>	Maximum Output Enable Time	$R_L = 1 \text{ k}\Omega, C_L = 50 \text{ pF}$	15	30	38	45	ns
	Enable Time	$R_L$ = 1 k $\Omega$ , $C_L$ = 150 pF	20	40	50	60	ns
t <sub>PHZ</sub> , t <sub>PLZ</sub>	Maximum Output Disable Time	$R_L = 1 \text{ k}\Omega, C_L = 50 \text{ pF}$	15	30	38	45	ns
t <sub>THL</sub> , t <sub>TLH</sub>	Maximum Output Rise and Fall Time	C <sub>L</sub> = 50 pF	6	12	15	18	ns
C <sub>IN</sub>	Maximum Input Capacitance		5	10	10	10	pF
C <sub>OUT</sub>	Maximum Output Capacitance		15	20	20	20	pF
C <sub>PD</sub>	Power Dissipation Capacitance (Note 3)	$\frac{\text{(per output)}}{\overline{G}} = V_{CC}$ $\overline{G} = GND$	12 50	-			pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product

performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3.  $C_{PD}$  determines the no load dynamic power consumption,  $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$ , and the no load dynamic current consumption,  $I_S = C_{PD} V_{CC} f + I_{CC}$ .

#### **AC ELECTRICAL CHARACTERISTICS**

(MM74HCT541: V<sub>CC</sub> = 5.0 V,  $t_r = t_f = 6$  ns,  $T_A = 25^{\circ}C$ , unless otherwise specified)

Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Unit
t <sub>PHL</sub> , t <sub>PLH</sub>	Maximum Output Propagation Delay	C <sub>L</sub> = 45 pF	13	20	ns
t <sub>PZL</sub> , t <sub>PZH</sub>	Maximum Output Enable Time	$C_L$ = 45 pF, $R_L$ = 1 k $\Omega$	17	28	ns
t <sub>PLZ</sub> , t <sub>PHZ</sub>	Maximum Output Disable Time	$C_L$ = 5 pF, $R_L$ = 1 k $\Omega$	15	25	ns

#### AC ELECTRICAL CHARACTERISTICS

(MM74HCT541: V\_{CC} = 5.0 V  $\pm$ 10%, t<sub>r</sub> = t<sub>f</sub> = 6 ns, unless otherwise specified)

			T <sub>A</sub> =	25°C	$T_A = -40^{\circ}C$ to $85^{\circ}C$	$T_A = -55^{\circ}C$ to $125^{\circ}C$	
Symbol	Parameter	Conditions	Тур		Guaranteed Li	imits	Unit
t <sub>PHL</sub> , t <sub>PLH</sub>	Maximum Output	C <sub>L</sub> = 50 pF	14	23	29	34	ns
	Propagation Delay	C <sub>L</sub> = 150 pF	17	33	42	49	
t <sub>PZH</sub> , t <sub>PZL</sub>	Maximum Output	$R_L = 1 \text{ k}\Omega, C_L = 50 \text{ pF}$	17	30	38	45	ns
	Enable Time	$R_L = 1 \text{ k}\Omega, C_L = 150 \text{ pF}$	22	40	50	60	ns
t <sub>PHZ</sub> , t <sub>PLZ</sub>	Maximum Output Disable Time	$R_L = 1 \text{ k}\Omega, C_L = 50 \text{ pF}$	17	30	38	45	ns
t <sub>THL</sub> , t <sub>TLH</sub>	Maximum Output Rise and Fall Time	C <sub>L</sub> = 50 pF	6	12	15	18	ns
C <sub>IN</sub>	Maximum Input Capacitance		5	10	10	10	pF
C <sub>OUT</sub>	Maximum Output Capacitance		15	20	20	20	pF
C <sub>PD</sub>	Power Dissipation Capacitance (Note 4)	$\frac{\text{(per output)}}{\overline{G}} = V_{CC}$ $\overline{G} = GND$	12 45	-			pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product

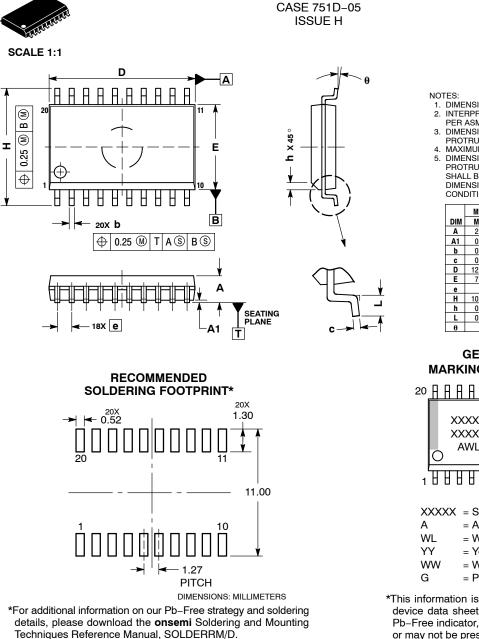
performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4.  $C_{PD}$  determines the no load dynamic power consumption,  $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$ , and the no load dynamic current consumption,  $I_S = C_{PD} V_{CC} f + I_{CC}$ .

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MM74HCT540MTCX	TSSOP-20 (Pb-Free)	2500 Units / Tape & Reel
MM74HCT541WM	SOIC-20 (Pb-Free)	38 Units / Tube
MM74HCT541MTCX	TSSOP-20 (Pb-Free)	2500 Units / Tape & Reel
MM74HCT541MTC	TSSOP-20 (Pb-Free)	75 Units / Tube
MM74HCT541WMX	SOIC-20 (Pb-Free)	1000 Units / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

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SOIC-20 WB

DATE 22 APR 2015

- NOTES:
  DIMENSIONS ARE IN MILLIMETERS.
  INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
  DIMENSIONS D AND E DO NOT INCLUDE MOLD
- DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS				
DIM	MIN	MAX			
Α	2.35	2.65			
A1	0.10	0.25			
b	0.35	0.49			
C	0.23	0.32			
D	12.65	12.95			
E	7.40	7.60			
е	1.27	BSC			
н	10.05	10.55			
h	0.25	0.75			
L	0.50	0.90			
θ	0 °	7 °			

GENERIC **MARKING DIAGRAM\*** 

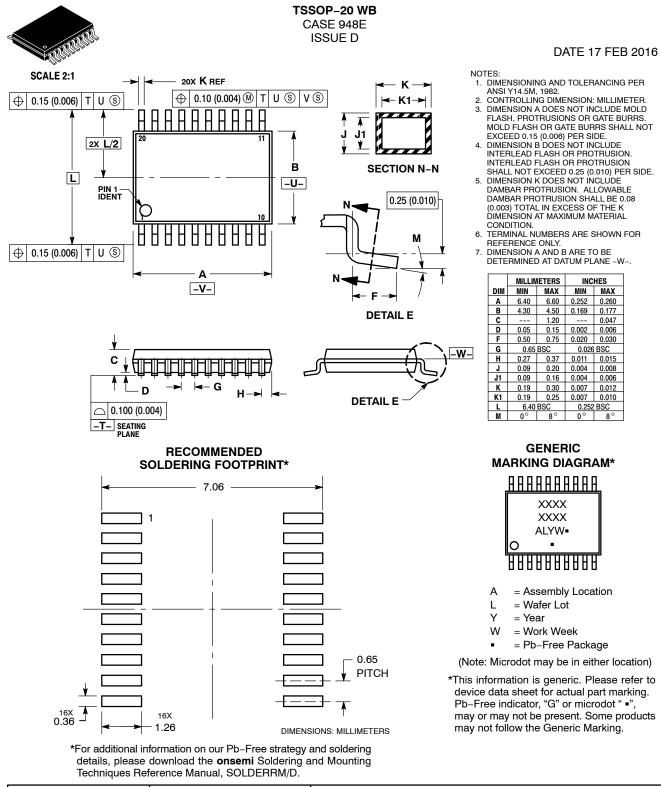
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XXXXX = Specific Device Code A = Assembly Location WL = Wafer Lot YY = Year WW = Work Week

= Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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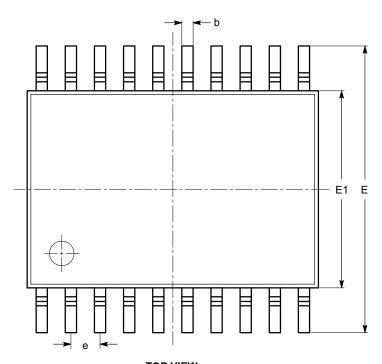
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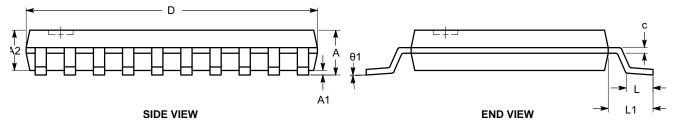
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SYMBOL	MIN	NOM	MAX
STMBOL			
А			1.20
A1	0.05		0.15
A2	0.80		1.05
b	0.19		0.30
С	0.09		0.20
D	6.40	6.50	6.60
Е	6.30	6.40	6.50
E1	4.30	4.40	4.50
е		0.65 BSC	
L	0.45	0.60	0.75
L1		1.00 REF	
θ	0°		8°





#### Notes:

All dimensions are in millimeters. Angles in degrees.
 Complies with JEDEC MO-153.

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